DATA SHEET

SA576
Low power compandor

Product specification

IC17 Data Handbook

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Philips
Semiconductors

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Low power compandor SA576

DESCRIPTION

The SA576 is a unity gain level programmable compandor designed for low power applications. The SA576 is internally configured as an expandor and a compressor to minimize external component count.

The SA576 can operate at 1.8V. During normal operations, the SA576 can operate from at least a 2V battery. If the battery voltage drops to 1.8V, this part will still continue to function, however, turning on the part at a V_{CC} of 1.8V requires two external resistors to bring V_{REF} to half V_{CC}. One resistor connects between V_{CC} and V_{REF}; the other connects from V_{REF} to ground. A typical value for these external resistors is approximately 20k. A lower value can be used, but the power consumption will go up.

The SA576 is available in a 14-pin plastic DIP and SO packages.

FEATURES

- Operating voltage range: 1.8V to 7V
- Low power consumption (1.4mA @ 3.6V)
- Over 80dB of dynamic range
- Wide input/output swing capability (rail-to-rail)
- Low external component count
- ESD hardened

PIN CONFIGURATION

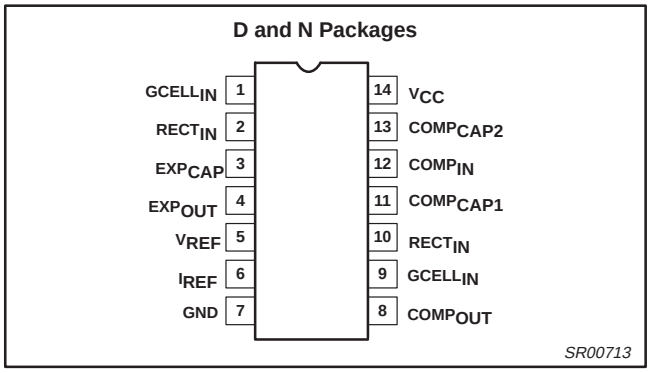


Figure 1. Pin Configuration

APPLICATIONS

- Cordless telephone
- Consumer audio
- Wireless microphones
- Modems
- Electric organs
- Hearing aids
- Automatic level control

ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
14-Pin Plastic Dual In-Line Package (DIP)	–40 to +85°C	SA576N	SOT27-1
14-Pin Plastic Small Outline (SO)	–40 to +85°C	SA576D	SOT108-1

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNITS
		SA576	
V_{CC}	Supply voltage	8	V
T_A	Operating ambient temperature range	–40 to +85	°C
T_{STG}	Storage temperature range	–65 to +150	°C
θ_{JA}	Thermal impedance DIP SO	90 125	°C/W °C/W

BLOCK DIAGRAM and TEST AND APPLICATION CIRCUIT

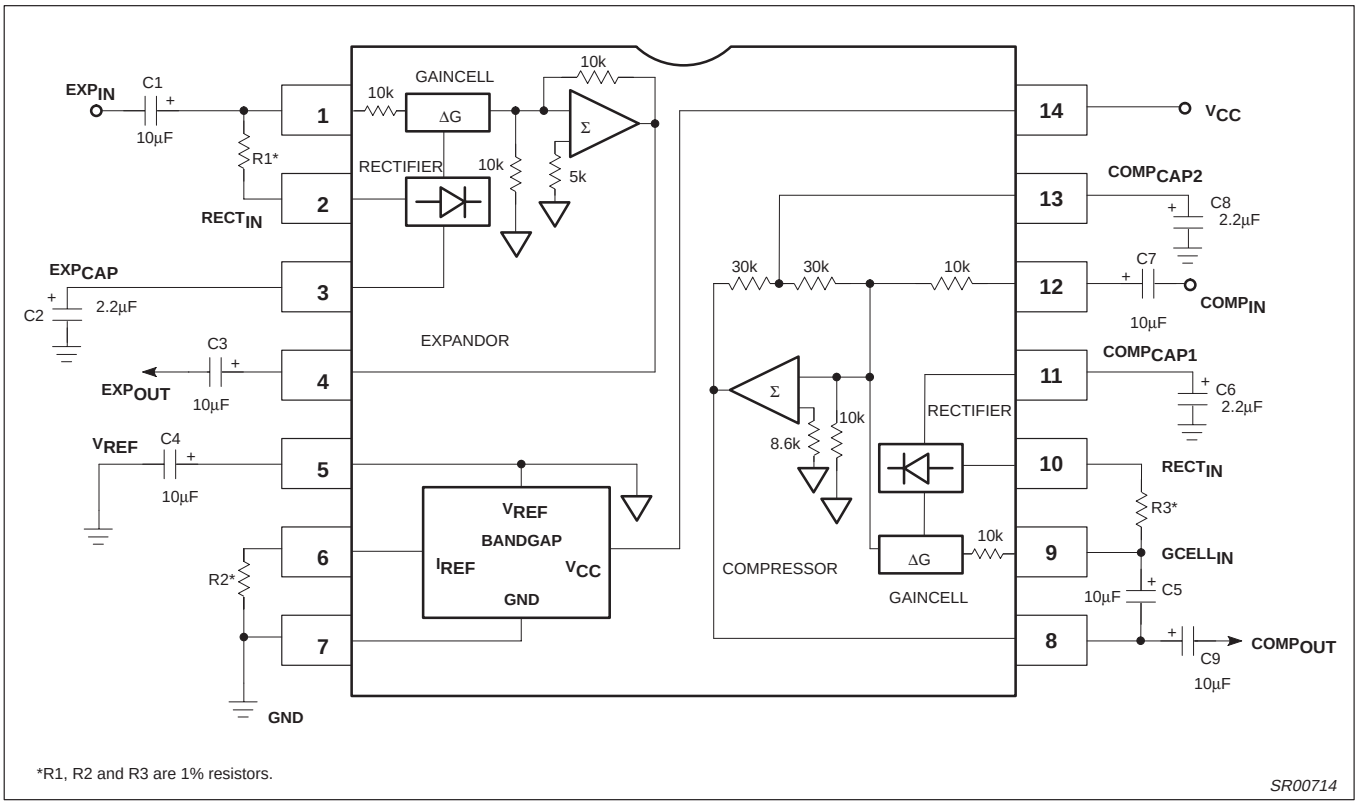


Figure 2. Block Diagram and Test and Application Circuit

ELECTRICAL CHARACTERISTICS

T_A = 25°C, V_{CC} = 3.6VDC, compandor 0dB level = –20dBV = 100mV_{RMS}, output load R_L = 10kΩ, Freq = 1kHz, unless otherwise specified. R1, R2 and R3 are 1% resistors.

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNITS
			SA576			
			MIN	TYP	MAX	
V_{CC}	Supply voltage[1]		2	3.6	7	V
I_{CC}	Supply current	No signal R_2 = 100kΩ		1.4	3	mA
V_{REF}	Reference voltage[2]	V_{CC} = 3.6V		1.8		V
R_L	Summing amp output load		10			kΩ
THD	Total harmonic distortion	1kHz, 0dB, BW = 3.5kHz		0.25	1.5	%
E_{NO}	Expandor output noise voltage	BW = 20kHz, R_S = 0Ω		10	30	µV
0dB	Unity gain level	0dB at 1kHz	–1.5	0.18	1.5	dB
V_{OS}	Output voltage offset	No signal	–150	1	150	mV
	Expandor output DC shift	No signal to 0dB	–100	7	100	mV
	Tracking error relative to 0dB output	-20dB expandor	–1.0	0.3	1.0	dB
	Crosstalk, COMP to EXP	1kHz, 0dB, C_{REF} = 10µF		–80		dB
V_O	Output swing low			0.2		V
	Output swing high			V_{CC} – 0.2		

NOTE:
1. Operation down to V_{CC} = 1.8V is possible, see description on front page of SA576 data sheet.
2. Reference voltage, V_{REF}, is typically at 1/2 V_{CC}.

TYPICAL PERFORMANCE CHARACTERISTICS

V_{CC} = 3.6V, T_A = 25°C, R1=R3=7.15kΩ, R2=100kΩ, 0dB level = 100mV, Freq. = 1kHz

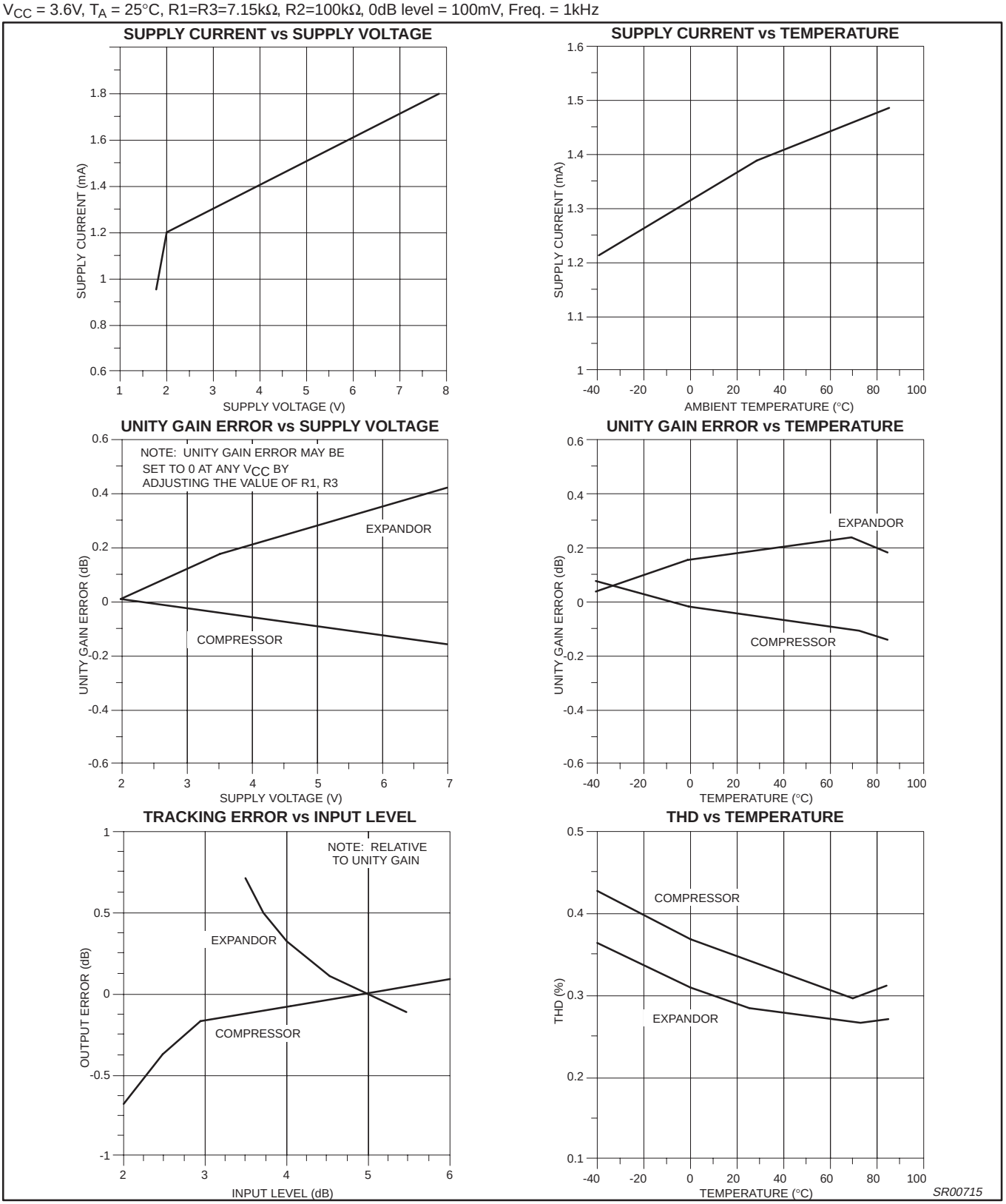
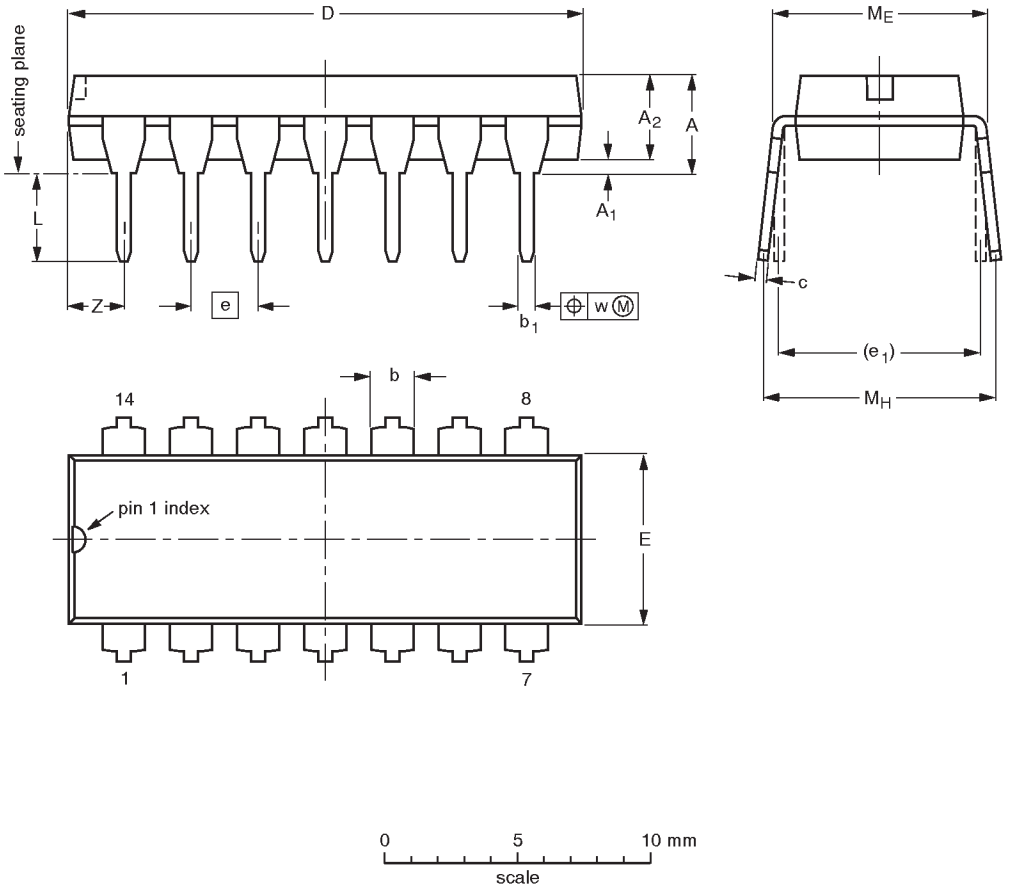


Figure 3. Typical Performance Characteristics

DIP14: plastic dual in-line package; 14 leads (300 mil) **SOT27-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

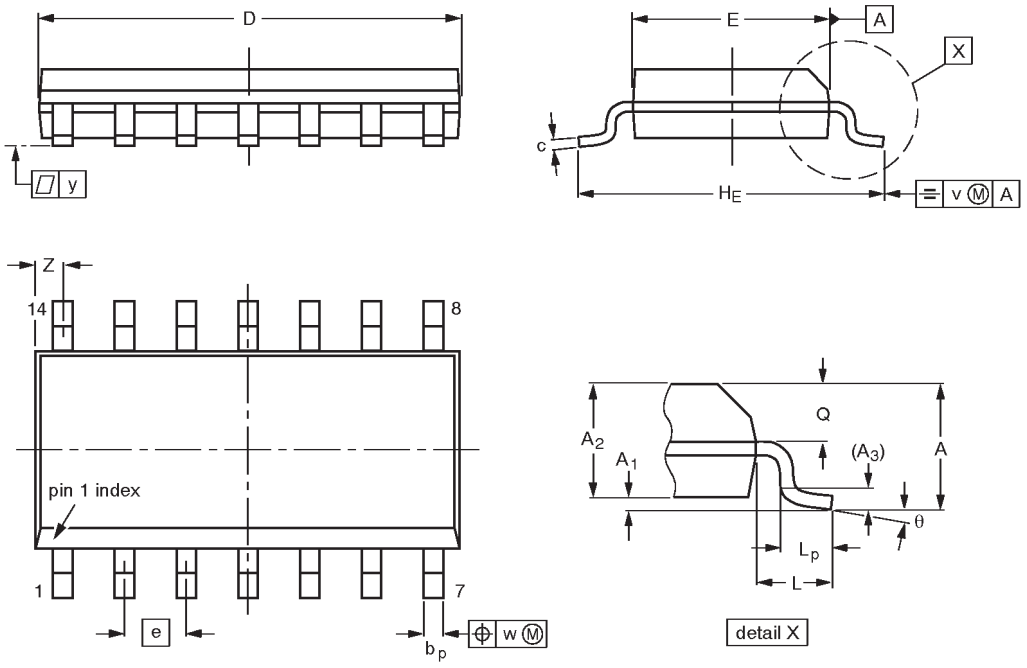
UNIT	A max.	A_1 min.	A_2 max.	b	b_1	c	D (1)	E (1)	e	e_1	L	M_E	M_H	w	Z (1) max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

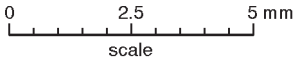
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT27-1	050G04	MO-001AA				~~92-11-17~~ 95-03-11

SO14: plastic small outline package; 14 leads; body width 3.9 mm SOT108-1





DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.35 0.34	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06S	MS-012AB				~~91-08-13~~ 95-01-23

DEFINITIONS

Data Sheet Identification	Product Status	Definition
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
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Philips Semiconductors
811 East Arques Avenue
P.O. Box 3409
Sunnyvale, California 94088–3409
Telephone 800-234-7381

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